#### **Features**

- Fast Read Access Time 70 ns
- 5-volt Only Reprogramming
- Sector Program Operation
  - Single Cycle Reprogram (Erase and Program)
  - 1024 Sectors (128 Bytes/sector)
  - Internal Address and Data Latches for 128 Bytes
- Two 8K Bytes Boot Blocks with Lockout
- Internal Program Control and Timer
- Hardware and Software Data Protection
- Fast Sector Program Cycle Time 10 ms
- DATA Polling for End of Program Detection
- Low Power Dissipation
  - 50 mA Active Current
  - 100 µA CMOS Standby Current
- Typical Endurance > 10,000 Cycles
- Single 5V ± 10% Supply
- CMOS and TTL Compatible Inputs and Outputs
- Commercial and Industrial Temperature Ranges

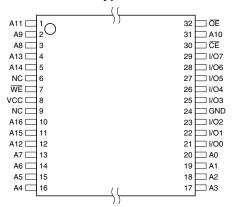
### **Description**

The AT29C010A is a 5-volt-only in-system Flash programmable and erasable read only memory (PEROM). Its 1 megabit of memory is organized as 131,072 words by 8 bits. Manufactured with Atmel's advanced nonvolatile CMOS technology, the device offers access times to 70 ns with power dissipation of just 275 mW over the commercial temperature range. When the device is deselected, the CMOS standby current is

### **Pin Configurations**

Pin Name	Function
A0 - A16	Addresses
CE	Chip Enable
ŌĒ	Output Enable
WE	Write Enable
I/O0 - I/O7	Data Inputs/Outputs
NC	No Connect

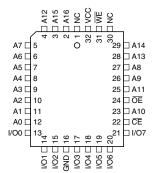
TSOP Top View Type 1



#### **DIP Top View**

		$\bigcirc$		l
NC □	1		32	□ vcc
A16 □	2		31	□WE
A15 🗆	3		30	□ NC
A12 🗆	4		29	□ A14
A7 □	5		28	□ A13
A6 □	6		27	□ A8
A5 □	7		26	□ A9
A4 □	8		25	□ A11
A3 □	9		24	D OE
A2 □	10		23	□ A10
A1 □	11		22	D CE
A0 □	12		21	1/07
I/O0 [	13		20	1/06
I/O1 [	14		19	1/05
I/O2 [	15		18	1/04
GND □	16		17	1/03
				l

#### **PLCC Top View**





1-megabit (128K x 8) 5-volt Only Flash Memory

## AT29C010A

Rev. 0394F-FLASH-02/03



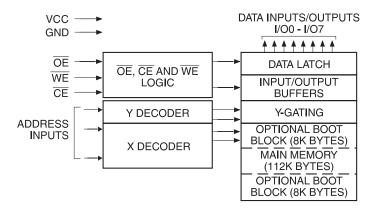


less than 100  $\mu$ A. The device endurance is such that any sector can typically be written to in excess of 10,000 times.

To allow for simple in-system reprogrammability, the AT29C010A does not require high input voltages for programming. Five-volt-only commands determine the operation of the device. Reading data out of the device is similar to reading from an EPROM. Reprogramming the AT29C010A is performed on a sector basis; 128 bytes of data are loaded into the device and then simultaneously programmed.

During a reprogram cycle, the address locations and 128 bytes of data are internally latched, freeing the address and data bus for other operations. Following the initiation of a program cycle, the device will automatically erase the sector and then program the latched data using an internal control timer. The end of a program cycle can be detected by DATA polling of I/O7. Once the end of a program cycle has been detected, a new access for a read or program can begin.

### **Block Diagram**



### **Device Operation**

**READ:** The AT29C010A is accessed like an EPROM. When  $\overline{\text{CE}}$  and  $\overline{\text{OE}}$  are low and  $\overline{\text{WE}}$  is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in the high impedance state whenever  $\overline{\text{CE}}$  or  $\overline{\text{OE}}$  is high. This dual-line control gives designers flexibility in preventing bus contention.

**BYTE LOAD:** Byte loads are used to enter the 128 bytes of a sector to be programmed or the software codes for data protection. A byte load is performed by applying a low pulse on the  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$  input with  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  low (respectively) and  $\overline{\text{OE}}$  high. The address is latched on the falling edge of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$ , whichever occurs last. The data is latched by the first rising edge of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$ .

**PROGRAM:** The device is reprogrammed on a sector basis. If a byte of data within a sector is to be changed, data for the entire sector must be loaded into the device. The data in any byte that is not loaded during the programming of its sector will be indeterminate. Once the bytes of a sector are loaded into the device, they are simultaneously programmed during the internal programming period. After the first data byte has been loaded into the device, successive bytes are entered in the same manner. Each new byte to be programmed must have its high to low transition on  $\overline{\text{WE}}$  (or  $\overline{\text{CE}}$ ) within 150  $\mu$ s of the low to high transition of  $\overline{\text{WE}}$  (or  $\overline{\text{CE}}$ ) of the preceding byte. If a high to low transition is not detected within 150  $\mu$ s of the last low to high transition, the load period will end and the internal programming period will start. A7 to A16 specify the sector address.

The sector address must be valid during each high to low transition of  $\overline{\text{WE}}$  (or  $\overline{\text{CE}}$ ). A0 to A6 specify the byte address within the sector. The bytes may be loaded in any order; sequential loading is not required. Once a programming operation has been initiated, and for the duration of  $t_{\text{WC}}$ , a read operation will effectively be a polling operation.

**SOFTWARE DATA PROTECTION:** A software controlled data protection feature is available on the AT29C010A. Once the software protection is enabled a software algorithm must be issued to the device before a program may be performed. The software protection feature may be enabled or disabled by the user; when shipped from Atmel, the software data protection feature is disabled. To enable the software data protection, a series of three program commands to specific addresses with specific data must be performed. After the software data protection is enabled the same three program commands must begin each program cycle in order for the programs to occur. All software program commands must obey the sector program timing specifications. Once set, the software data protection feature remains active unless its disable command is issued. Power transitions will not reset the software data protection feature, however the software feature will guard against inadvertent program cycles during power transitions.

Once set, software data protection will remain active unless the disable command sequence is issued.

After setting SDP, any attempt to write to the device without the 3-byte command sequence will start the internal write timers. No data will be written to the device; however, for the duration of  $t_{WC}$ , a read operation will effectively be a polling operation.

After the software data protection's 3-byte command code is given, a byte load is performed by applying a low pulse on the  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$  input with  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  low (respectively) and  $\overline{\text{OE}}$  high. The address is latched on the falling edge of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$ , whichever occurs last. The data is latched by the first rising edge of  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$ . The 128 bytes of data must be loaded into each sector by the same procedure as outlined in the program section under device operation.

**HARDWARE DATA PROTECTION:** Hardware features protect against inadvertent programs to the AT29C010A in the following ways: (a)  $V_{CC}$  sense – if  $V_{CC}$  is below 3.8V (typical), the program function is inhibited; (b)  $V_{CC}$  power on delay – once  $V_{CC}$  has reached the  $V_{CC}$  sense level, the device will automatically time out 5 ms (typical) before programming; (c) Program inhibit – holding any one of  $\overline{OE}$  low,  $\overline{CE}$  high or  $\overline{WE}$  high inhibits program cycles; and (d) Noise filter—pulses of less than 15 ns (typical) on the  $\overline{WE}$  or  $\overline{CE}$  inputs will not initiate a program cycle.

**PRODUCT IDENTIFICATION:** The product identification mode identifies the device and manufacturer as Atmel. It may be accessed by hardware or software operation. The hardware operation mode can be used by an external programmer to identify the correct programming algorithm for the Atmel product. In addition, users may wish to use the software product identification mode to identify the part (i.e. using the device code), and have the system software use the appropriate sector size for program operations. In this manner, the user can have a common board design for 256K to 4-megabit densities and, with each density's sector size in a memory map, have the system software apply the appropriate sector size.

For details, see Operating Modes (for hardware operation) or Software Product Identification. The manufacturer and device code is the same for both modes.

**DATA POLLING:** The AT29C010A features DATA polling to indicate the end of a program cycle. During a program cycle an attempted read of the last byte loaded will result in the complement of the loaded data on I/O7. Once the program cycle has been completed, true data is valid on all outputs and the next cycle may begin. DATA polling may begin at any time during the program cycle.





**TOGGLE BIT:** In addition to DATA polling the AT29C010A provides another method for determining the end of a program or erase cycle. During a program or erase operation, successive attempts to read data from the device will result in I/O6 toggling between one and zero. Once the program cycle has completed, I/O6 will stop toggling and valid data will be read. Examining the toggle bit may begin at any time during a program cycle.

**OPTIONAL CHIP ERASE MODE:** The entire device can be erased by using a 6-byte software code. Please see Software Chip Erase application note for details.

**BOOT BLOCK PROGRAMMING LOCKOUT:** The AT29C010A has two designated memory blocks that have a programming lockout feature. This feature prevents programming of data in the designated block once the feature has been enabled. Each of these blocks consists of 8K bytes; the programming lockout feature can be set independently for either block. While the lockout feature does not have to be activated, it can be activated for either or both blocks.

These two 8K memory sections are referred to as *boot blocks*. Secure code which will bring up a system can be contained in a boot block. The AT29C010A blocks are located in the first 8K bytes of memory and the last 8K bytes of memory. The boot block programming lockout feature can therefore support systems that boot from the lower addresses of memory or the higher addresses. Once the programming lockout feature has been activated, the data in that block can no longer be erased or programmed; data in other memory locations can still be changed through the regular programming methods. To activate the lockout feature, a series of seven program commands to specific addresses with specific data must be performed. Please see Boot Block Lockout Feature Enable Algorithm.

If the boot block lockout feature has been activated on either block, the chip erase function will be disabled.

**BOOT BLOCK LOCKOUT DETECTION:** A software method is available to determine whether programming of either boot block section is locked out. See Software Product Identification Entry and Exit sections. When the device is in the software product identification mode, a read from location 00002 will show if programming the lower address boot block is locked out while reading location 1FFF2 will do so for the upper boot block. If the data is FE, the corresponding block can be programmed; if the data is FF, the program lockout feature has been activated and the corresponding block cannot be programmed. The software product identification exit mode should be used to return to standard operation.

### Absolute Maximum Ratings\*

п	
	Temperature Under Bias55°C to +125°C
	Storage Temperature65°C to +150°C
	All Input Voltages (including NC Pins) with Respect to Ground0.6V to +6.25V
	All Output Voltages with Respect to Ground0.6V to $V_{\rm CC}$ + 0.6V
	Voltage on $\overline{\text{OE}}$ with Respect to Ground0.6V to +13.5V

\*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

# **DC and AC Operating Range**

		AT29C010A-70	AT29C010A-90	AT29C010A-12	AT29C010A-15
Operating	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C	0°C - 70°C
Temperature (Case)	Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C
V <sub>CC</sub> Power Supply	·	5V ± 5%	5V ± 10%	5V ± 10%	5V ± 10%

Note: Not recommended for New Designs.

# **Operating Modes**

Mode	CE	ŌĒ	WE	Ai	I/O
Read	V <sub>IL</sub>	V <sub>IL</sub>	V <sub>IH</sub>	Ai	D <sub>OUT</sub>
Program <sup>(2)</sup>	$V_{IL}$	V <sub>IH</sub>	$V_{IL}$	Ai	D <sub>IN</sub>
5V Chip Erase	V <sub>IL</sub>	V <sub>IH</sub>	V <sub>IL</sub>	Ai	
Standby/Write Inhibit	V <sub>IH</sub>	X <sup>(1)</sup>	Х	X	High Z
Program Inhibit	Х	Х	V <sub>IH</sub>		
Program Inhibit	Х	V <sub>IL</sub>	Х		
Output Disable	Х	V <sub>IH</sub>	Х		High Z
Product Identification					
Hardware	V <sub>IL</sub>	V <sub>IL</sub>	V <sub>IH</sub>	A1 - A16 = V <sub>IL</sub> , A9 = V <sub>H</sub> , (3) A0 = V <sub>IL</sub>	Manufacturer Code <sup>(4)</sup>
				A1 - A16 = V <sub>IL</sub> , A9 = V <sub>H</sub> , (3) A0 = V <sub>IH</sub>	Device Code <sup>(4)</sup>
Software <sup>(5)</sup>				A0 = V <sub>IL</sub>	Manufacturer Code <sup>(4)</sup>
				A0 = V <sub>IH</sub>	Device Code <sup>(4)</sup>

- Notes: 1. X can be  $V_{\rm IL}$  or  $V_{\rm IH}$ . 2. Refer to AC Programming Waveforms.
  - 3.  $V_H = 12.0V \pm 0.5V$ .
  - 4. Manufacturer Code: 1F, Device Code: D5.
  - 5. See details under Software Product Identification Entry/Exit.

### **DC Characteristics**

Symbol	Parameter	Condition		Min	Max	Units
I <sub>LI</sub>	Input Load Current	V <sub>IN</sub> = 0V to V <sub>CC</sub>			10	μΑ
I <sub>LO</sub>	Output Leakage Current	$V_{I/O} = 0V \text{ to } V_{CC}$			10	μΑ
I <sub>SB1</sub>	V <sub>CC</sub> Standby Current CMOS	$\overline{\text{CE}} = \text{V}_{\text{CC}} - 0.3 \text{V to V}_{\text{CC}}$	0° - 40°C		30	μА
			Com.		100	μΑ
			Ind.		300	μΑ
I <sub>SB2</sub>	V <sub>CC</sub> Standby Current TTL	$\overline{\text{CE}}$ = 2.0V to V <sub>CC</sub>			3	mA
I <sub>CC</sub>	V <sub>CC</sub> Active Current	f = 5 MHz; I <sub>OUT</sub> = 0 mA			50	mA
V <sub>IL</sub>	Input Low Voltage				0.8	V
V <sub>IH</sub>	Input High Voltage			2.0		V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA			0.45	V
V <sub>OH1</sub>	Output High Voltage	I <sub>OH</sub> = -400 μA		2.4		V
V <sub>OH2</sub>	Output High Voltage CMOS	$I_{OH} = -100 \ \mu A; \ V_{CC} = 4.5 V$		4.2		V





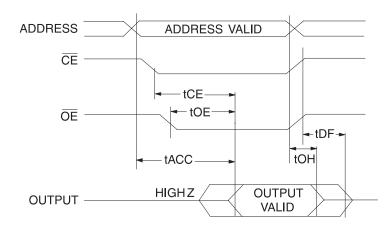
### **AC Read Characteristics**

		AT29C010A-70		AT29C010A-90		AT29C010A-12		AT29C010A-15		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	Units
t <sub>ACC</sub>	Address to Output Delay		70		90		120		150	ns
t <sub>CE</sub> <sup>(1)</sup>	CE to Output Delay		70		90		120		150	ns
t <sub>OE</sub> <sup>(2)</sup>	OE to Output Delay	0	35	0	40	0	50	0	70	ns
t <sub>DF</sub> <sup>(3)(4)</sup>	CE or OE to Output Float	0	25	0	25	0	30	0	40	ns
t <sub>OH</sub>	Output Hold from $\overline{OE}$ , $\overline{CE}$ or Address, whichever occurred first	0		0		0		0		ns

Note:

Not recommended for New Designs.

# AC Read Waveforms<sup>(1)(2)(3)(4)</sup>

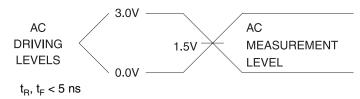


- Notes: 1.  $\overline{CE}$  may be delayed up to  $t_{ACC}$   $t_{CE}$  after the address transition without impact on  $t_{ACC}$ .

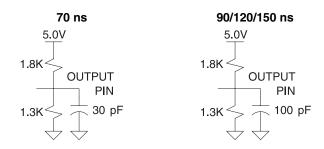
  2.  $\overline{OE}$  may be delayed up to  $t_{CE}$   $t_{OE}$  after the falling edge of  $\overline{CE}$  without impact on  $t_{CE}$  or by  $t_{ACC}$   $t_{OE}$  after an address change without impact on  $t_{ACC}$ . 3.  $t_{DF}$  is specified from  $\overline{OE}$  or  $\overline{CE}$  whichever occurs first (CL = 5 pF).

  - 4. This parameter is characterized and is not 100% tested.

# **Input Test Waveforms and Measurement Level**



## **Output Test Load**



## **Pin Capacitance**

 $f = 1 \text{ MHz}, T = 25^{\circ}C^{(1)}$ 

Symbol	Тур	Max	Units	Conditions
C <sub>IN</sub>	4	6	pF	$V_{IN} = 0V$
C <sub>OUT</sub>	8	12	pF	$V_{OUT} = 0V$

Note: 1. This parameter is canharacterized and is not 100% tested.

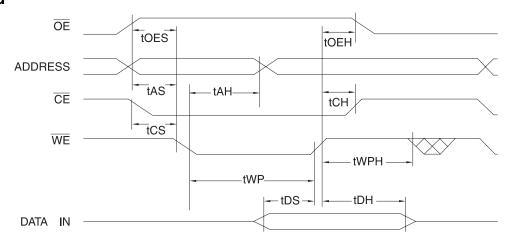


# **AC Byte Load Characteristics**

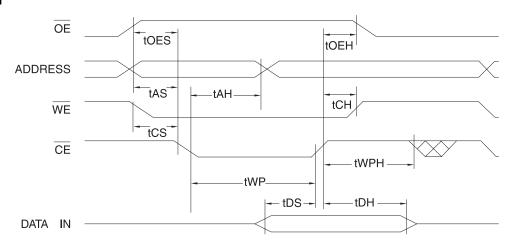
Symbol	Parameter	Min	Max	Units
t <sub>AS</sub> , t <sub>OES</sub>	Address, OE Set-up Time	0		ns
t <sub>AH</sub>	Address Hold Time	50		ns
t <sub>CS</sub>	Chip Select Set-up Time	0		ns
t <sub>CH</sub>	Chip Select Hold Time	0		ns
t <sub>WP</sub>	Write Pulse Width (WE or CE)	90		ns
t <sub>DS</sub>	Data Set-up Time	35		ns
t <sub>DH</sub> , t <sub>OEH</sub>	Data, $\overline{\text{OE}}$ Hold Time	0		ns
t <sub>WPH</sub>	Write Pulse Width High	100		ns

# **AC Byte Load Waveforms**

### **WE** Controlled



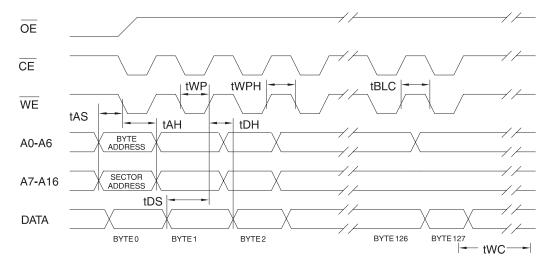
### **CE** Controlled



## **Program Cycle Characteristics**

Symbol	Parameter	Min	Max	Units
t <sub>WC</sub>	Write Cycle Time		10	ms
t <sub>AS</sub>	Address Set-up Time	0		ns
t <sub>AH</sub>	Address Hold Time	50		ns
t <sub>DS</sub>	Data Set-up Time	35		ns
t <sub>DH</sub>	Data Hold Time	0		ns
t <sub>WP</sub>	Write Pulse Width	90		ns
t <sub>BLC</sub>	Byte Load Cycle Time		150	μs
t <sub>WPH</sub>	Write Pulse Width High	100		ns

# **Program Cycle Waveforms**<sup>(1)(2)(3)</sup>



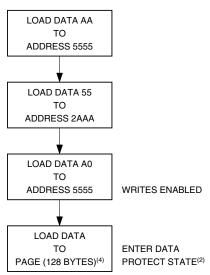
Notes:

- 1. A7 through A16 must specify the sector address during each high to low transition of WE (or CE).
- 2.  $\overline{\text{OE}}$  must be high when  $\overline{\text{WE}}$  and  $\overline{\text{CE}}$  are both low.
- 3. All bytes that are not loaded within the sector being programmed will be indeterminate.



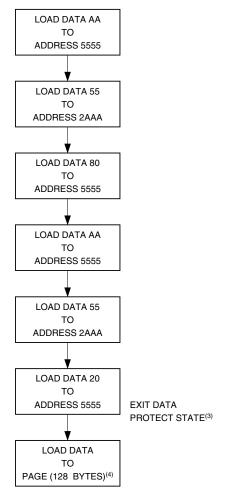


## **Software Data Protection Enable** Algorithm<sup>(1)</sup>

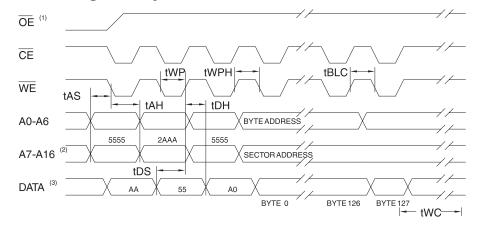


- Notes: 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 - A0 (Hex).
  - 2. Data Protect state will be activated at end of program cycle.
  - 3. Data Protect state will be deactivated at end of program period.
  - 4. 128 bytes of data MUST BE loaded.

## **Software Data Protection Disable** Algorithm<sup>(1)</sup>



# **Software Protected Program Cycle Waveform**(1)(2)(3)



- Notes: 1. A7 through A16 must specify the sector address during each high to low transition of WE (or CE) after the software code has been entered.
  - 2.  $\overline{OE}$  must be high when  $\overline{WE}$  and  $\overline{CE}$  are both low.
  - 3. All bytes that are not loaded within the sector being programmed will be indeterminate.

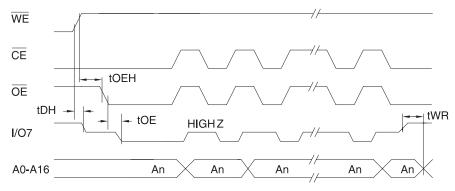
# **Data** Polling Characteristics<sup>(1)</sup>

Symbol	Parameter	Min	Тур	Max	Units
t <sub>DH</sub>	Data Hold Time	10			ns
t <sub>OEH</sub>	OE Hold Time	10			ns
t <sub>OE</sub>	OE to Output Delay <sup>(2)</sup>				ns
t <sub>WR</sub>	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See  $t_{\text{OE}}$  spec in AC Read Characteristics.

### **Data Polling Waveforms**



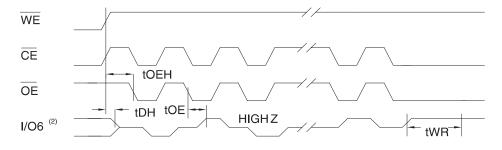
# Toggle Bit Characteristics<sup>(1)</sup>

Symbol	Parameter	Min	Тур	Max	Units
t <sub>DH</sub>	Data Hold Time	10			ns
t <sub>OEH</sub>	OE Hold Time	10			ns
t <sub>OE</sub>	OE to Output Delay <sup>(2)</sup>				ns
t <sub>OEHP</sub>	OE High Pulse	150			ns
t <sub>WR</sub>	Write Recovery Time	0			ns

Notes: 1. These parameters are characterized and not 100% tested.

2. See  $t_{\text{OE}}$  spec in AC Read Characteristics.

## Toggle Bit Waveforms<sup>(1)(2)(3)</sup>



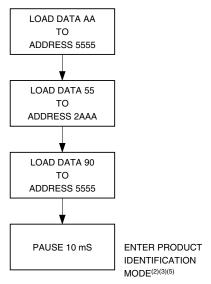
Notes: 1. Toggling either  $\overline{OE}$  or  $\overline{CE}$  or both  $\overline{OE}$  and  $\overline{CE}$  will operate toggle bit.

- 2. Beginning and ending state of I/O6 will vary.
- 3. Any address location may be used but the address should not vary.

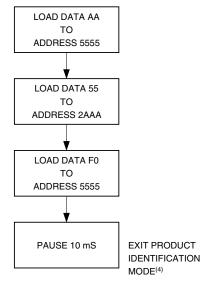




## **Software Product Identification** Entry<sup>(1)</sup>

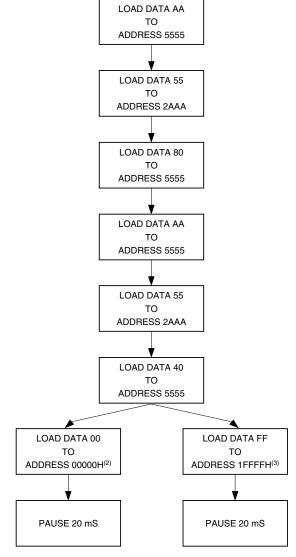


## **Software Product Identification Exit<sup>(1)</sup>**



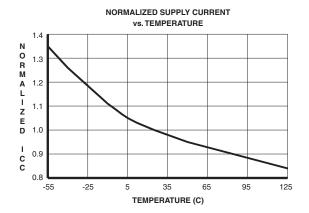
- Notes: 1. Data Format: I/O7 I/O0 (Hex); Address Format: A14 - A0 (Hex).
  - 2.  $A1 A15 = V_{IL}$ . Manufacturer Code is read for A0 = V<sub>IL</sub>; Device Code is read for  $A0 = V_{IH}$ .
  - 3. The device does not remain in identification mode if powered down.
  - 4. The device returns to standard operation mode.
  - 5. Manufacturer Code is 1F. The Device Code is D5.

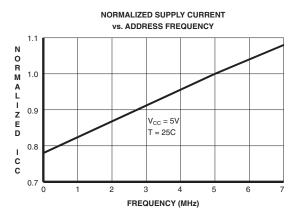
## **Boot Block Lockout Feature Enable** Algorithm<sup>(1)</sup>

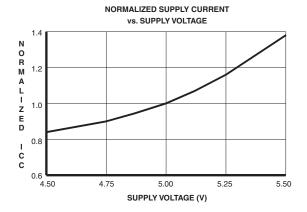


Notes: 1. Data Format: I/O7 - I/O0 (Hex); Address Format: A14 - A0 (Hex).

- 2. Lockout feature set on lower address boot block.
- 3. Lockout feature set on higher address boot block.











# **Ordering Information**

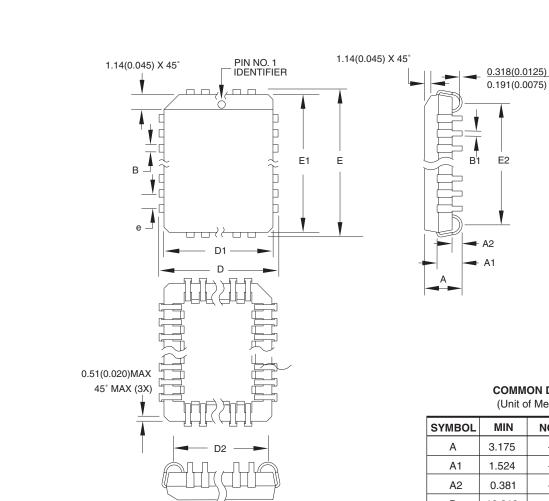
t <sub>ACC</sub>	I <sub>cc</sub>	(mA)			
(ns)	Active	Standby	Ordering Code	Package	<b>Operation Range</b>
70	50	0.1	AT29C010A-70JC	32J	Commercial
			AT29C010A-70PC	32P6	(0° to 70°C)
			AT29C010A-70TC	32T	
			AT29C010A-70JI	32J	Industrial
			AT29C010A-70PI	32P6	(-40° to 85°C)
			AT29C010A-70TI	32T	
90	50	0.1	AT29C010A-90JC	32J	Commercial
			AT29C010A-90PC	32P6	(0° to 70°C)
			AT29C010A-90TC	32T	
50 0.3		AT29C010A-90JI	32J	Industrial	
			AT29C010A-90PI	32P6	(-40° to 85°C)
			AT29C010A-90TI	32T	
120	50	0.1	AT29C010A-12JC	32J	Commercial
			AT29C010A-12PC	32P6	(0° to 70°C)
			AT29C010A-12TC	32T	
	50	0.3	AT29C010A-12JI	32J	Industrial
			AT29C010A-12PI	32P6	(-40° to 85°C)
			AT29C010A-12TI	32T	
150	50	0.1	AT29C010A-15JC	32J	Commercial
			AT29C010A-15PC	32P6	(0° to 70°C)
			AT29C010A-15TC	32T	
	50	0.3	AT29C010A-15JI	32J	Industrial
			AT29C010A-15PI	32P6	(-40° to 85°C)
			AT29C010A-15TI	32T	

Note: Not recommended for New Designs.

Package Type		
32J	32-lead, Plastic J-leaded Chip Carrier (PLCC)	
32P6	32-lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)	
32T	32-lead, Thin Small Outline Package (TSOP)	

## **Packaging Information**

### **32J - PLCC**



Notes:

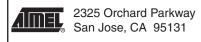
- 1. This package conforms to JEDEC reference MS-016, Variation AE.
- Dimensions D1 and E1 do not include mold protrusion.
   Allowable protrusion is .010"(0.254 mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
- 3. Lead coplanarity is 0.004" (0.102 mm) maximum.

#### **COMMON DIMENSIONS**

(Unit of Measure = mm)

MIN	NOM	MAX	NOTE
3.175	_	3.556	
1.524	-	2.413	
0.381	_	_	
12.319	_	12.573	
11.354	-	11.506	Note 2
9.906	_	10.922	
14.859	-	15.113	
13.894	_	14.046	Note 2
12.471	-	13.487	
0.660	_	0.813	
0.330	_	0.533	
1.270 TYP			
	3.175 1.524 0.381 12.319 11.354 9.906 14.859 13.894 12.471 0.660 0.330	3.175 - 1.524 - 0.381 - 12.319 - 11.354 - 9.906 - 14.859 - 13.894 - 12.471 - 0.660 - 0.330 -	3.175     -     3.556       1.524     -     2.413       0.381     -     -       12.319     -     12.573       11.354     -     11.506       9.906     -     10.922       14.859     -     15.113       13.894     -     14.046       12.471     -     13.487       0.660     -     0.813       0.330     -     0.533

10/04/01



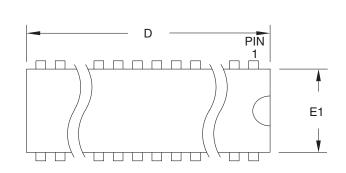
IIILE		
<b>32J</b> , 32-lead,	Plastic J-leaded	Chip Carrier (PLCC)

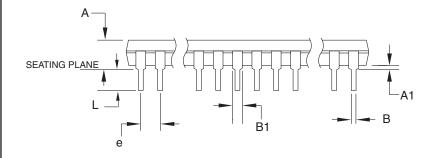
DRAWING NO. REV.

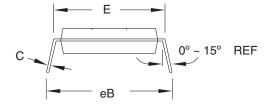




#### 32P6 - PDIP







Note: 1. Dimensions D and E1 do not include mold Flash or Protrusion.

Mold Flash or Protrusion shall not exceed 0.25 mm (0.010").

### COMMON DIMENSIONS

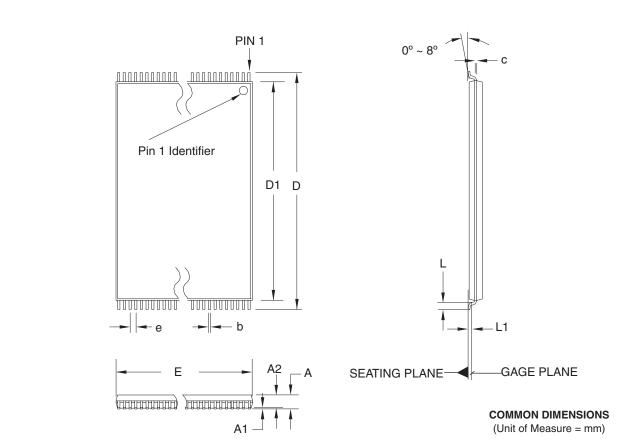
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
Α	_	_	4.826	
A1	0.381	_	-	
D	41.783	_	42.291	Note 1
E	15.240	_	15.875	
E1	13.462	_	13.970	Note 1
В	0.356	_	0.559	
B1	1.041	_	1.651	
L	3.048	_	3.556	
С	0.203	_	0.381	
eB	15.494	_	17.526	
е	2.540 TYP		•	

09/28/01

		DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	<b>32P6</b> , 32-lead (0.600"/15.24 mm Wide) Plastic Dual Inline Package (PDIP)	32P6	В

#### **32T - TSOP**



Notes:

- 1. This package conforms to JEDEC reference MO-142, Variation BD.
- 2. Dimensions D1 and E do not include mold protrusion. Allowable protrusion on E is 0.15 mm per side and on D1 is 0.25 mm per side.
- 3. Lead coplanarity is 0.10 mm maximum.

SYMBOL	MIN	NOM	MAX	NOTE
Α	_	_	1.20	
A1	0.05	_	0.15	
A2	0.95	1.00	1.05	
D	19.80	20.00	20.20	
D1	18.30	18.40	18.50	Note 2
E	7.90	8.00	8.10	Note 2
L	0.50	0.60	0.70	
L1	0.25 BASIC			
b	0.17	0.22	0.27	
С	0.10	_	0.21	
е	0.50 BASIC			

10/18/01

1	TITLE
	32T, 32-lead (8 x 20 mm Package) Plastic Thin Small Outline
	Package, Type I (TSOP)

RAWING NO.	REV.
32T	В





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